

### **Overview**

The R46 series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V-0.

# **Applications**

For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X2 safety classification. Intended for use in situations in which capacitor failure would not result in exposure to electric shock. Not for use in "series with mains" type applications.

### **Benefits**

- Approvals: ENEC, UL, cUL, CQC
- X2 CLASS (IEC 60384-14)
- Rated voltage: 310 VAC 50/60 Hz
- Capacitance range: 0.01 15 μF
- Lead spacing: 10.0 37.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category 40/125/56, IEC 60068-1
- Tape & Reel in accordance with IEC 60286-2
- · RoHS compliant and lead-free terminations
- Operating temperature range of -40°C to +125°C
- 100% screening factory test at 2,200 VDC/1,500 VAC
- Self healing properties



Part	Num	ber	System
- ure			<b>J</b>

R46	3	N	3220	00	H1	Μ
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
X2, Metallized Polypropylene	3 = 310	F = 10.0 I = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	H = High Temperature H1 H2 H3 H4 H7	K = ±10% M = ±20%



# **Ordering Options Table**

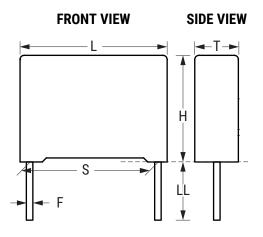
Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4+2/-0	00
	Ammo Pack	H <sub>0</sub> = 18.5 ±0.5	DQ <sup>1</sup>
	Other Lead and Packaging Options		
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 ±0.5	СК
10	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 ±0.5	GY <sup>1</sup>
15	Bulk (Bag)² – Short Leads	2.7 +0.5/-0	JA
22.5	Bulk (Bag)² – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag)² – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag)² – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4+2/-0	00
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 ±0.5	CK <sup>1</sup>
	Other Lead and Packaging Options		
	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
27.5	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray )– Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4+2/-0	00
	Other Lead and Packaging Options	4127 0	
	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
37.5	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads		50
	Duik (11dy) - Lolly Leaus	25 +2/-1	50

<sup>1</sup> Not for all sizes, see "Packaging Quantities" table.

 $^2$  For lead spacing 22.5 case sizes  $\ge$  8.5\*17\*26.5 the parts are packed in a Pizza box 335\*320\*34 mm



### **Dimensions – Millimeters**



	S		Г	ł	4		L	I	F
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
10.0	±0.4	4.0	+0.2/-0.5	9.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
10.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
10.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
15.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	17.5	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.2/-0.5	13.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.2/-0.5	18.5	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	8.5	+0.2/-0.5	14.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	9.0	+0.2/-0.5	12.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	10.0	+0.2/-0.5	16.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	11.0	+0.2/-0.5	19.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	13.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
22.5	±0.4	6.0	+0.2/-0.5	15.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	7.0	+0.2/-0.5	16.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	10.0	+0.2/-0.5	18.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	11.0	+0.2/-0.5	20.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	13.0	+0.2/-0.5	22.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
27.5	±0.4	9.0	+0.2/-0.7	17.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	11.0	+0.2/-0.7	20.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	22.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	25.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	14.0	+0.2/-0.7	28.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	18.0	+0.2/-0.7	33.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	22.0	+0.2/-0.7	37.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
37.5	±0.4	11.0	+0.3/-0.7	22.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	13.0	+0.3/-0.7	24.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	16.0	+0.3/-0.7	28.5	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	19.0	+0.3/-0.7	32.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	20.0	+0.3/-0.7	40.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	24.0	+0.3/-0.7	44.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	30.0	+0.3/-0.7	45.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
		Note: Se	e Ordering O	ptions Tabl	e for lead ler	ngth (LL/H <sub>o</sub> )	options.		

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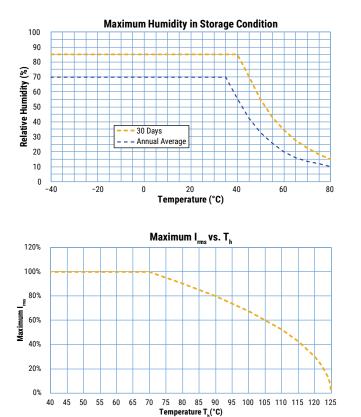
### **Performance Characteristics**

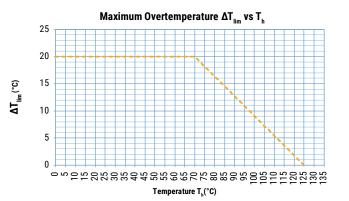
Dielectric	Polypropylene film							
Plates	Metal layer deposited by	Metal layer deposited by evaporation under vacuum						
Winding	Non-inductive type	Non-inductive type						
Leads	Tinned wire							
Protection	Plastic case, thermosetting	g resin filled. Box material is s	olvent resistant and flame reta	ardant according to UL94.				
Related Documents	IEC 60384-14, EN 60384	-14						
Rated Voltage V <sub>R</sub>	310 VAC (50/60 Hz)							
Recommended DC Voltage	≤ 630 VDC							
Capacitance Range	0.010 – 15 µF							
Capacitance Values	E6 series (IEC 60063) me	easured at 1 kHz and +20 ±1	°C					
Capacitance Tolerance	±10%, ±20%							
Temperature Range	-40°C to +125°C							
Climatic Category	40/125/56 IEC 60068-1							
Reliability	Operational life 100,000	hours at 85°C; 2,000 hours a	at 125°C					
	Storage time: $\leq$ 24 months from the date marked on the label package							
	Average relative humidity per year ≤ 70%							
Storage Conditions	RH $\leq$ 85% for 30 days randomly distributed throughout the year							
	Dew is absent							
	Temperature: -40 to 80°C (see "Maximum Humidity in Storage Conditions" graph below)							
Approvals	ENEC, UL, cUL, CQC							
		Maximum Va	lues at +23°C					
Dissipation Factor (tanδ)			C ≤ 0.1 µF	C > 0.1 µF				
	Frequenc	•	0.3%	0.2%				
Test Voltage Between Terminals	The voltage level is selected All electrical characteristic	ry test is carried out at 2,200 ed to meet the requirements cs are checked after the test. EMET is not liable in such ca	in applicable equipment stan This test cannot be repeated					
		Measured at +25°C ±5°C,	according to IEC 60384–2					
hand store Destate		Minimum Values E	Between Terminals					
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF				
	100 VDC	1 minute	≥ 1 • 10⁵ MΩ ( ≥ 5 • 10⁵ MΩ )*	≥ 30,000 MΩ • μF (≥ 150,000 MΩ • μF )*				

\* Typical value

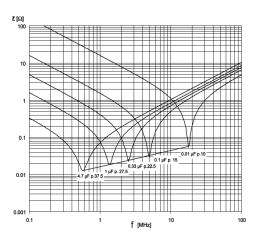


# Performance Characteristics cont.



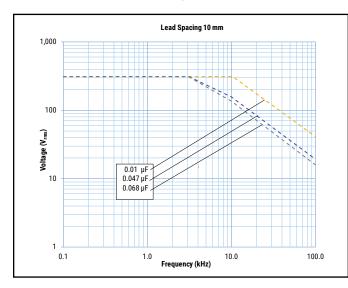


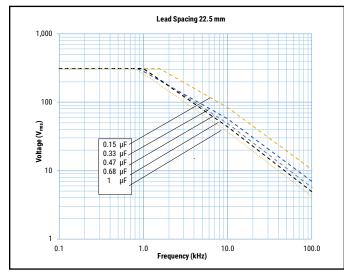
 $T_h$  is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in °C.

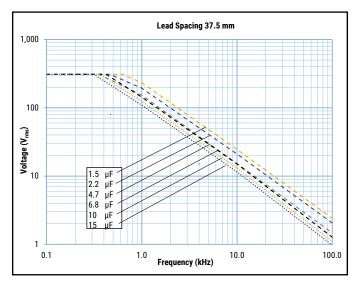


# **Impedance Graph**

# Maximum Voltage ( $V_{rms}$ ) Versus Frequency (Sinusoidal Waveform/Th $\leq$ 70°C)

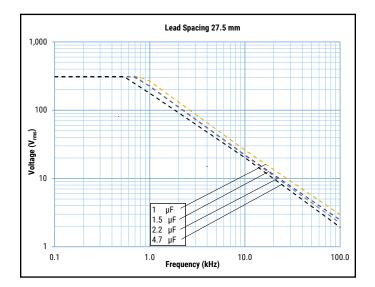




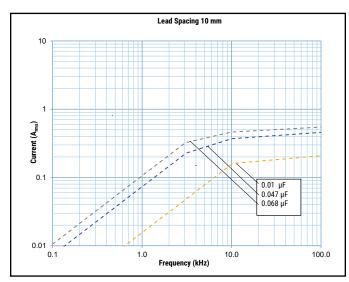


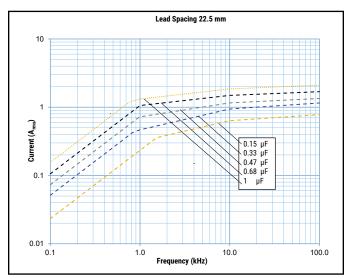
Lead Spacing 15 mm 1,000 100 Voltage (V<sub>rms</sub>) 0.01 µI 0.047 μF 0.1 μF 10 0.15 μF 0.22 μF 0.33 µF 0.47 µF 1 0.1 1.0 10.0 100.0 Frequency (kHz)

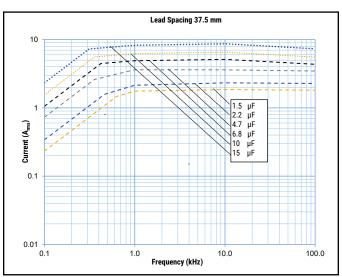
KENNET



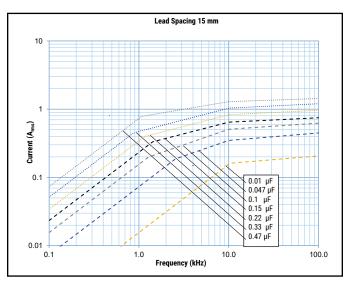




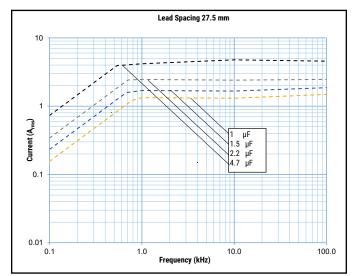








KENIET





# **Environmental Test Data**

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384-14	1.25 x V <sub>R</sub> VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s <sup>2</sup>
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s <sup>2</sup>
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V <sub>R</sub> + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days

# **Approvals**

Certification Body	Mark	Specification	File Number
IMQ S-p.A.		EN/IEC 60384-14	CA08.00063
UL	c SN <sup>®</sup> us	UL 60384–14 and CAN/CSA E60384–14 (310 VAC)	E97797
CQC		IEC 60384-14	CQC15001128630 CQC15001128703 CQC15001128705

# **Environmental Compliance**

All KEMET EMI capacitors are RoHS compliant.





# Table 1 – Ratings & Part Number Reference

Capacitance	Dime	ensions ir	n mm	Lead Spacing	dV/dt	KEMET	Legacy Part
Value (µF)	Т	Н	L	(S)	(V/µs)	Part Number	Number
0.01	4.0	9.0	13.0	10.0	500	463F2100(1)H7(2)	R463F2100(1)H7(2)
0.01	5.0	11.0	13.0	10.0	500	463F2100(1)H1(2)	R463F2100(1)H1(2)
0.015	4.0	9.0	13.0	10.0	500	463F2150(1)H7(2)	R463F2150(1)H7(2)
0.015	5.0	11.0	13.0	10.0	500	463F2150(1)H1(2)	R463F2150(1)H1(2)
0.022	4.0	9.0	13.0	10.0	500	463F2220(1)H7(2)	R463F2220(1)H7(2)
0.022	5.0	11.0	13.0	10.0	500	463F2220(1)H1(2)	R463F2220(1)H1(2)
0.033	5.0	11.0	13.0	10.0	500	463F2330(1)H1(2)	R463F2330(1)H1(2)
0.047	5.0	11.0	13.0	10.0	500	463F2470(1)H7(2)	R463F2470(1)H7(2)
0.047	6.0	12.0	13.0	10.0	500	463F2470(1)H1(2)	R463F2470(1)H1(2)
0.068	6.0	12.0	13.0	10.0	500	463F2680(1)H1(3)	R463F2680(1)H1(3)
0.010	5.0	11.0	18.0	15.0	400	463I2100(1)H1(2)	R463I2100(1)H1(2)
0.015	5.0	11.0	18.0	15.0	400	463I2150(1)H1(2)	R463I2150(1)H1(2)
0.022	5.0	11.0	18.0	15.0	400	463I2220(1)H1(2)	R463I2220(1)H1(2)
0.033	5.0	11.0	18.0	15.0	400	463I2330(1)H1(2)	R463I2330(1)H1(2)
0.047	5.0	11.0	18.0	15.0	400	463I2470(1)H1(2)	R463I2470(1)H1(2)
0.068	5.0	11.0	18.0	15.0	400	463I2680(1)H1(2)	R463I2680(1)H1(2)
0.10	5.0	11.0	18.0	15.0	400	463I3100(1)H7(2)	R463I3100(1)H7(2)
0.10	6.0	12.0	18.0	15.0	400	463I3100(1)H1(2)	R463I3100(1)H1(2)
0.15	6.0	12.0	18.0	15.0	400	463I3150(1)H7(2)	R463I3150(1)H7(2)
0.15	6.0	17.5	18.0	15.0	400	463I3150(1)H2(2)	R463I3150(1)H2(2)
0.15	9.0	12.5	18.0	15.0	400	463I3150(1)H3(2)	R463I3150(1)H3(2)
0.15	7.5	13.5	18.0	15.0	400	463I3150(1)H1(2)	R463I3150(1)H1(2)
0.22	7.5	13.5	18.0	15.0	400	463I3220(1)H7(2)	R463I3220(1)H7(2)
0.22	8.5	14.5	18.0	15.0	400	463I3220(1)H1(2)	R463I3220(1)H1(2)
0.22	6.0	17.5	18.0	15.0	400	463I3220(1)H2(3)	R463I3220(1)H2(3)
0.22 0.22	9.0 7.5	12.5	18.0 18.0	15.0 15.0	400 400	463I3220(1)H3(3)	R463I3220(1)H3(3)
	7.5 8.5	18.5 14.5		15.0		463I3220(1)H4(2)	R463I3220(1)H4(2)
0.33 0.33	8.5 10.0	14.5	18.0 18.0	15.0	400 400	463I3330(1)H7(2) 463I3330(1)H1(3)	R463I3330(1)H7(2) R463I3330(1)H1(3)
0.33	7.5	18.5	18.0	15.0	400	463I3330(1)H2(3)	R463I3330(1)H1(3)
0.33	13.0	12.0	18.0	15.0	400	463I3330(1)H3(3)	R463I3330(1)H3(3)
0.33	10.0	16.0	18.0	15.0	400	463I3470(1)H7(3)	R46313470(1)H7(3)
0.47	11.0	19.0	18.0	15.0	400	463I3470(1)H1(3)	R463I3470(1)H1(3)
0.68	11.0	19.0	18.0	15.0	400	463I3680(1)H7(3)	R463I3680(1)H7(3)
0.15	6.0	15.0	26.5	22.5	200	463N3150(1)H1(2)	R463N3150(1)H1(2)
0.22	6.0	15.0	26.5	22.5	200	463N3220(1)H1(2)	R463N3220(1)H1(2)
0.33	6.0	15.0	26.5	22.5	200	463N3330(1)H7(2)	R463N3330(1)H7(2)
0.33	7.0	16.0	26.5	22.5	200	463N3330(1)H1(2)	R463N3330(1)H1(2)
0.47	7.0	16.0	26.5	22.5	200	463N3470(1)H7(2)	R463N3470(1)H7(2)
0.47	10.0	18.5	26.5	22.5	200	463N3470(1)H1(2)	R463N3470(1)H1(2)
0.68	10.0	18.5	26.5	22.5	200	463N3680(1)H7(2)	R463N3680(1)H7(2)
0.68	11.0	20.0	26.5	22.5	200	463N3680(1)H1(2)	R463N3680(1)H1(2)
1.0	11.0	20.0	26.5	22.5	200	463N4100(1)H7(2)	R463N4100(1)H7(2)
1.0	13.0	22.0	26.5	22.5	200	463N4100(1)H1(2)	R463N4100(1)H1(2)
1.5	13.0	22.0	26.5	22.5	200	463N4150(1)H7(2)	R463N4150(1)H7(2)
1	11.0	20.0	32.0	27.5	150	463R4100(1)H7(2)	R463R4100(1)H7(2)
1.5	13.0	22.0	32.0	27.5	150	463R4150(1)H7(2)	R463R4150(1)H7(2)
2.2	14.0	28.0	32.0	27.5	150	463R4220(1)H7(2)	R463R4220(1)H7(2)
3.3	18.0	33.0	32.0	27.5	150	463R4330(1)H7(2)	R463R4330(1)H7(2)
4.7	22.0	37.0	32.0	27.5	150	463R4470(1)H7(2)	R463R4470(1)H7(2)
1.5	11.0	22.0	41.5	37.5	100	463W4150(1)H7(2)	R463W4150(1)H7(2)
2.2	13.0	24.0	41.5	37.5	100	463W4220(1)H7(2)	R463W4220(1)H7(2)
3.3	16.0	28.5	41.5	37.5	100	463W4330(1)H7(2)	R463W4330(1)H7(2)
4.7	19.0	32.0	41.5	37.5	100	463W4470(1)H7(2)	R463W4470(1)H7(2)
6.8	20.0	40.0	41.5	37.5	100	463W4680(1)H7(2)	R463W4680(1)H7(2)
10	24.0	44.0	41.5	37.5	100	463W5100(1)H7(2)	R463W5100(1)H7(2)
15	30.0	45.0	41.5	37.5	100	463W5150(1)H7(3)	R463W5150(1)H7(3)
				Lead		KEMET	Legacy
Capacitance Value (µF)	T (mm)	H (mm)	L (mm)	Spacing (S)	dV/dt (V/µs)	Part Number	Part Number
				spacily (S)		Faitivullinel	

(1) Insert lead and packaging code. See Ordering Options Table for available options.

(2)  $M = \pm 20\%$ ,  $K = \pm 10\%$ 

(3)  $M = \pm 20\%$  (only available tolerance).



### **Soldering Process**

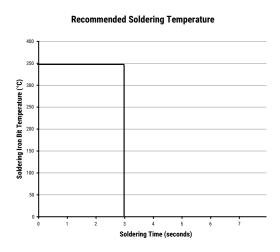
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder material. This has increased the liquidus temperature from 183°C for SnPb eutectic alloys to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher preheat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm). Great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above-recommended limits may result to degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal temperature before performing the second soldering cycle.

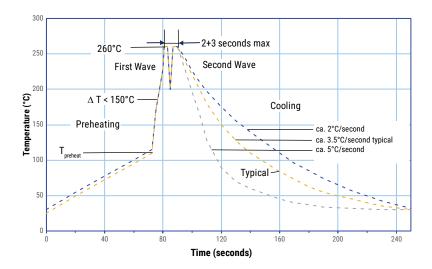
#### **Manual Soldering Recommendations**

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





### **Soldering Process cont.**

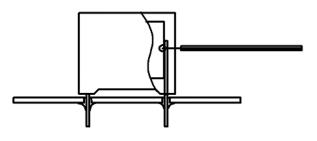
#### Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric Film Material	Maxi Prel Tempe	heat	Maximum Peak Soldering Temperature			
	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm		
Polyester	130°C	130°C	270°C	270°C		
Polypropylene	125°C	130°C	260°C	270°C		
Paper	130°C	140°C	270°C	270°C		
Polyphenylene Sulphide	150°C	160°C	270°C	270°C		

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature inside the element is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	125°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

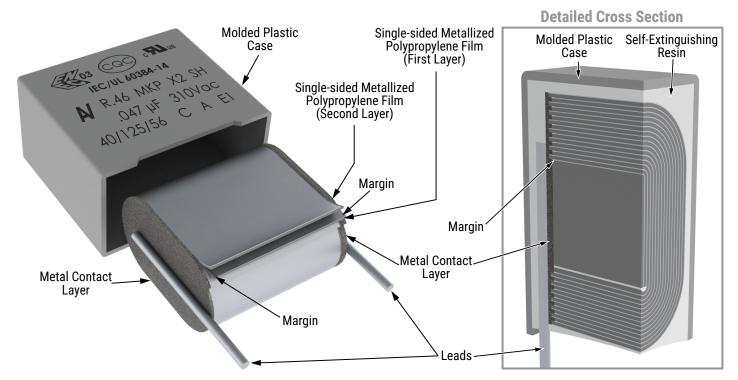
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as it is in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

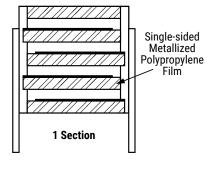
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 – 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.



### Construction



### Winding Scheme





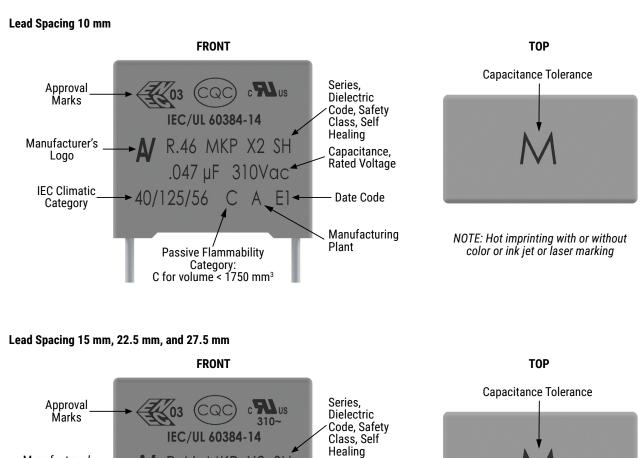
### Marking

Manufacturer's

Logo

**IEC Climatic** 

Category



Slight change in the layout can be possible but this does not affect the content of the information of the current marking. This change will be achieved without impact to product form, fit or function, as the products are equivalent with respect to physical, mechanical, quality and reliability characteristics.

Capacitance,

Date Code

Manufacturing Plant

Rated Voltage

R.46 MKP X2

Passive Flammability Category: B for volume ≥ 1750 mm<sup>3</sup> C for volume < 1750 mm<sup>3</sup>

.68 uF

125/56

SH

E

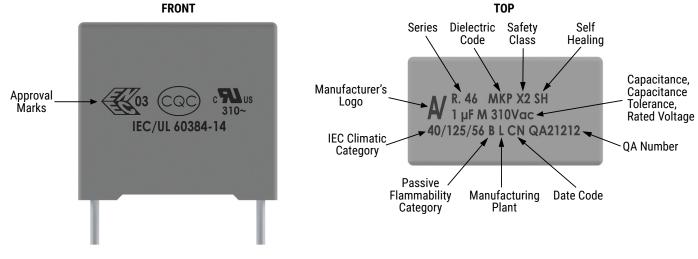
310Vac

NOTE: Hot imprinting with or without color or ink jet or laser marking



### Marking cont.

Lead Spacing 22.5 and 27.5 mm (alternatives\*) and 37.5 mm



\*Differences are caused by technology (clichee, laser, or ink) and production line.

Slight change in the layout can be possible but this does not affect the content of the information of the current marking. This change will be achieved without impact to product form, fit or function, as the products are equivalent with respect to physical, mechanical, quality and reliability characteristics.

	Manufacturing Date Code (IEC 60062)												
Year	Code	Year	Code	Year	Code	Month	Code	Month	Code				
2020	М	2027	V	2034	E	January	1	July	7				
2021	N	2028	W	2035	F	February	2	August	8				
2022	Р	2029	Х	2036	G	March	3	September	9				
2023	R	2030	Α	2037	Н	April	4	October	0				
2024	S	2031	В	2038	K	May	5	November	Ν				
2025	Т	2032	С	2039	L	June	6	December	D				
2026	U	2033	D	2040	М								



# **Packaging Quantities**

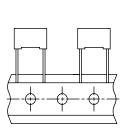
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads		ulk Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped
Lead and Packaging Code:			00 - JA - JB JE - JH	JM	40 - 50	GY	СК	DQ	
	4	9	13	2,000	2,200	1,800	750	1,500	1,000
10	5	11	13	1,300	2,000	1,500	600	1,250	800
	6	12	13	1,000	1,800	1,200	500	1,000	680
	F	11	10	0.000	1.050	1 0 0 0	(00)	1 050	000
	5	11	18	2,000	1,250	1,000	600	1,250	800
	6	12	18	1,750	1,000	900	500	1,000	680
	6	17.5	18	1,000	800	700	500	1,000	680
	7.5	13.5	18	1,000	800	700	350	800	500
15	7.5	18.5	18	900	650	500	-	800	500
	8.5	14.5	18	1,000	650	500	300	700	440
	9	12.5	18	1,000	700	520	270	650	410
	10	16	18	750	550	500	270	600	380
	11	19	18	450	400	350	-	500	340
	13	12	18	750	520	490	200	480	280
	6	15	26.5	805	450	500	-	700	464
	7	16	26.5	700	450	500	_	550	380
22.5	10	18.5	26.5	396	350	300	_	350	235
	11	20	26.5	360	200	250	_	350	217
	13	22	26.5	300	150	200	_	300	
	10		20.0		100	200			
	9	17	32	816	408	408	-	450	-
	11	20	32	560	336	336	-	350	-
27.5	13	22	32	480	288	288	-	300	-
27.5	14	28	32	352	176	176	-	-	-
	18	33	32	256	128	128	-	-	-
	22	37	32	168	112	112	-	-	-
	11	0.0	A1 F	400	050	050			
	11	22	41.5	420	252	252	-	-	-
	13	24	41.5	360	216	216	-	-	-
07.5	16	28.5	41.5	216	108	108	-	-	-
37.5	19	32	41.5	192	96	96	-	-	-
	20	40	41.5	126	84	84	-	-	-
	24	44	41.5	108	72	72	-	-	-
	30	45	41.5	90	60	60	-	-	-



### Lead Taping & Packaging (IEC 60286-2)



Figure 2 Lead Spacing 15 mm



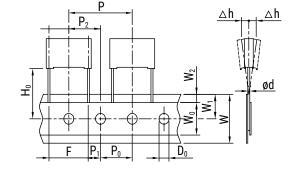
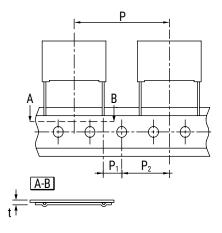


Figure 3 Lead Spacing 22.5 – 27.5 mm



### **Taping Specification**

Description	Symbol	Dimensions (mm)				
		Lead Space				
		10	15	22.5	27.5	Tol.
		Fig. 1	Fig. 2	Fig. 3	Fig. 3	
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05
Taping lead space	Р	25.4	25.4	38.1	38.1	±1
Feed hole lead space *	P <sub>0</sub>	12.7	12.7	12.7	12.7	±0.2 **
Centering of the lead wire	P <sub>1</sub>	7.7	5.2	7.8	5.3	±0.7
Centering of the body	P <sub>2</sub>	12.7	12.7	19.05	19.05	±1.3
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1
Component alignment	Δh	0	0	0	0	±2
Height of component from tape center	H <sub>0</sub> ****	18.5	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	18	+1/-0.5
Hold down tape width	W <sub>0</sub>	9	10	10	10	Minimum
Hole position	<b>W</b> <sub>1</sub>	9	9	9	9	±0.5
Hold down tape position	W <sub>2</sub>	3	3	3	3	Maximum
Feed hole diameter	D <sub>0</sub>	4	4	4	4	±0.2
Total tape thickness	t	0.7	0.7	0.7	0.7	±0.2

\* 15 mm also available

\*\* Maximum of 1 mm on 20 lead spaces

\*\*\* Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

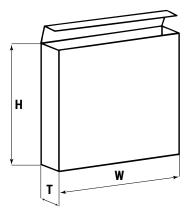
\*\*\*\*  $H_0$  = 16.5 mm is available upon request



# Lead Taping & Packaging (IEC 60286-2) cont.

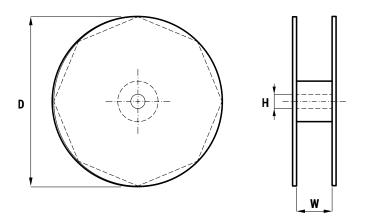
# **Ammo Specifications**

Dimensions (mm)						
Н	W	Т				
360	340	59				



# **Reel Specifications**

Reel Size	Dimensions (mm)				
Reel Size	D	Н	W		
Standard	355	30	55 Maximum		
Large	500	25			





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